

**CARRIER COMPRISING A LAYER FOR TRAPPING ELECTRICAL CHARGES FOR
A COMPOSITE SUBSTRATE**

Abstract

The invention relates to a method for preparing a carrier (1) for a composite substrate (S), which method comprises forming a superficial porous layer (P) on a first face (1c) of the carrier (1), and dispensing a viscous solution comprising a solvent and a precursor of a filler material on the first face (1c) of the carrier (1) so as to absorb at least some of the viscous solution in open pores of the superficial porous layer (P). In a fourth step, the carrier (1) is heat-treated to transform the viscous solution present in the open pores in order to fill the open pores with the filler material.

Fig. 3c